

RGT30NS65D

650V 15A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	15A
V _{CE(sat) (Typ.)}	1.65V
P_D	133W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating; RoHS Compliant

Applications

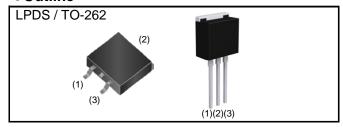
General Inverter

UPS

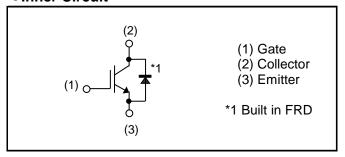
Power Conditioner

Welder

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Taping / Tube
	Reel Size (mm)	330 / -
Typo	Tape Width (mm)	24 / -
Type	Basic Ordering Unit (pcs)	1,000 / 1,000
	Packing code	TL / C9
	Marking	RGT30NS65D

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Collector - Emitter Voltage		V _{CES}	650	V	
Gate - Emitter Voltage	Gate - Emitter Voltage		±30	V	
	T _C = 25°C	I _C	30	А	
Collector Current	T _C = 100°C	I _C	15	А	
Pulsed Collector Current		I _{CP} *1	45	А	
Die de Fermand Oromani	T _C = 25°C	I _F	26	А	
Diode Forward Current	T _C = 100°C	l _F	15	А	
Diode Pulsed Forward Current		I _{FP} *1	45	А	
Power Dissipation	T _C = 25°C	P _D	133	W	
	T _C = 100°C	P _D	66	W	
Operating Junction Temperature		T _j	-40 to +175	°C	
Storage Temperature		T _{stg}	-55 to +175	°C	

^{*1} Pulse width limited by T_{jmax.}

●Thermal Resistance

Parameter	Symbol	Values			Linit
Farameter		Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	1.12	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	2.86	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_C = 10 \mu A, V_{GE} = 0 V$	650	-	-	V
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	ı	-	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 10.0 \text{mA}$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 15A$, $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.65 2.15	2.1	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	780	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	35	-	pF
Reverse Transfer Capacitance	C_{res}	f = 1MHz	-	13	-	
Total Gate Charge	Q _g	V _{CE} = 300V	-	32	-	
Gate - Emitter Charge	Q_ge	I _C = 15A	-	8	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	11	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 15A, V_{CC} = 400V$	-	18	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	20	-	ns
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	64	-	
Fall Time	t _f	Inductive Load	-	75	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 15A, V_{CC} = 400V$	-	18	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 10\Omega$	-	22	-	no
Turn - off Delay Time	t _{d(off)}	T _j = 175°C	-	74	-	ns
Fall Time	t _f	Inductive Load	-	130	-	
		$I_C = 45A, V_{CC} = 520V$				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650 V, V_{GE} = 15 V$	FULL SQUARE			-
		$R_G = 50\Omega, T_j = 175^{\circ}C$				
		V _{CC} ≦ 360V				
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V	5	-	-	μs
		T _j = 25°C				

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			l loit
			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V_{F}	$I_F = 15A$ $T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.5 1.3	1.95 -	V
Diode Reverse Recovery Time	t _{rr}	I _F = 15A	-	55	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	6.0	1	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 25°C	-	0.19	1	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 15A	-	141	1	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	9.5	1	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 175°C	-	0.79	-	μC

Fig.1 Power Dissipation vs. Case Temperature

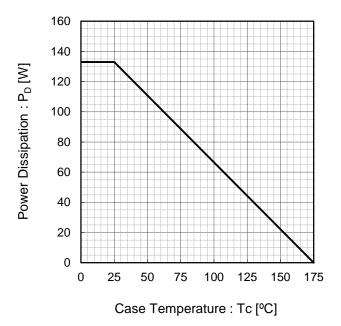


Fig.2 Collector Current vs. Case Temperature

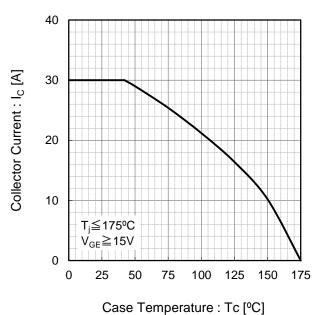


Fig.3 Forward Bias Safe Operating Area

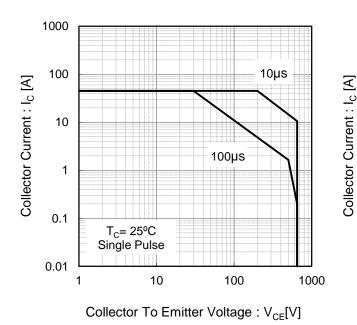
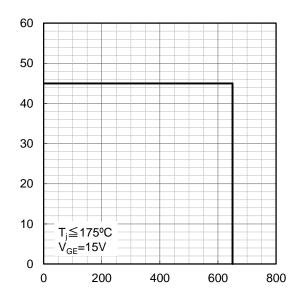


Fig.4 Reverse Bias Safe Operating Area



Collector To Emitter Voltage : V_{CE}[V]

Fig.5 Typical Output Characteristics

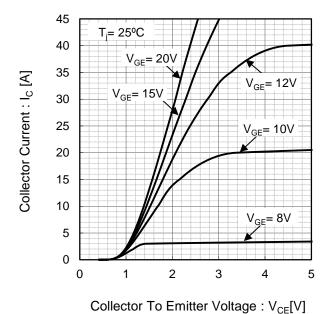
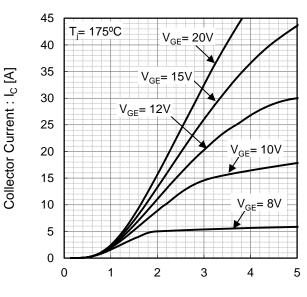


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V_{CE}[V]

Fig.7 Typical Transfer Characteristics

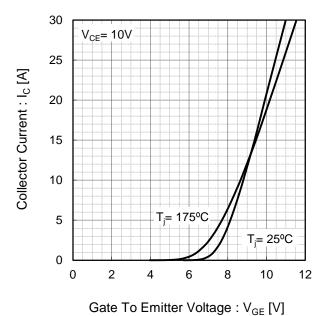
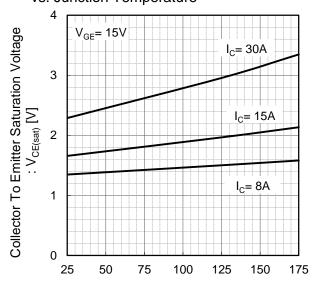
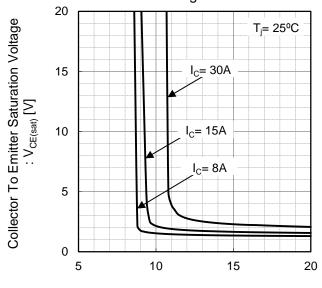


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



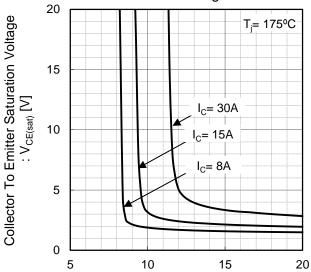
Junction Temperature : T_i [°C]

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



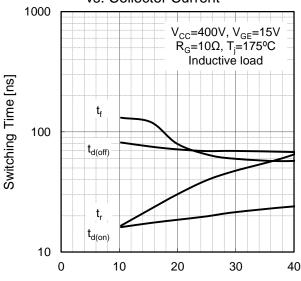
Gate To Emitter Voltage : V_{GE} [V]

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



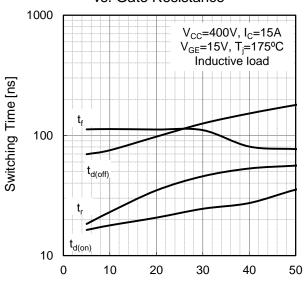
Gate To Emitter Voltage: V_{GE} [V]

Fig.11 Typical Switching Time vs. Collector Current



Collector Current : I_C [A]

Fig.12 Typical Switching Time vs. Gate Resistance



Gate Resistance : $R_G[\Omega]$

Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1 $\mathsf{E}_{\mathsf{off}}$ 0.1 E_{on} V_{CC} =400V, V_{GE} =15V R_{G} =10 Ω , T_{i} =175°C Inductive load 0.01 0 10 20 30 40 Collector Current : I_C [A]

vs. Gate Resistance 10 Switching Energy Losses [mJ] 1 $\mathsf{E}_{\mathsf{off}}$ 0.1 V_{CC}=400V, I_C=15A V_{GE}=15V, T_j=175°C Inductive load 0.01 40 0 10 20 30 50 Gate Resistance : $R_G[\Omega]$

Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] 100 Coes 10 f=1MHz Cres $V_{GE}=0V$ T_i=25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage : V_{CE}[V]

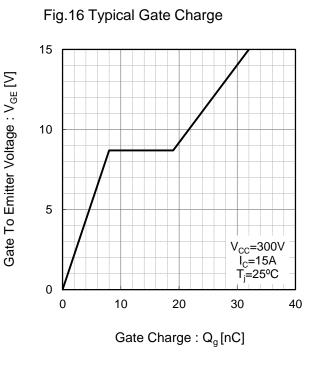


Fig.17 Typical Diode Forward Current vs. Forward Voltage 45 40 35 Forward Current : I_F [A] 30 25 20 15 T_i= 175°C 10 T_i= 25°C 5 0 0 0.5 1.5 2 2.5 3

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400 V_{CC} =400V di_F/dt=200A/µs Reverse Recovery Time: t_{rr} [ns] Inductive load 300 200 T_i= 175°C 100 $T_i = 25^{\circ}C$ 0 10 20 30 40 50 0

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

Forward Voltage: V_F[V]

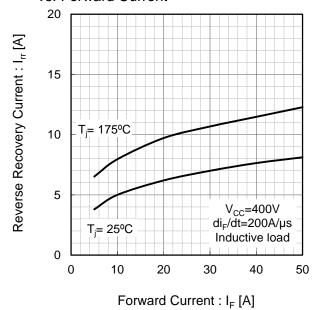
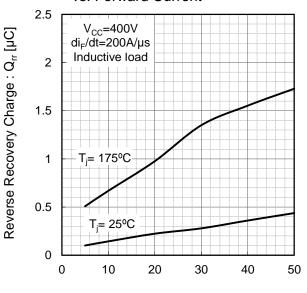


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current

Forward Current : I_F [A]



Forward Current : I_F [A]

Fig.21 IGBT Transient Thermal Impedance

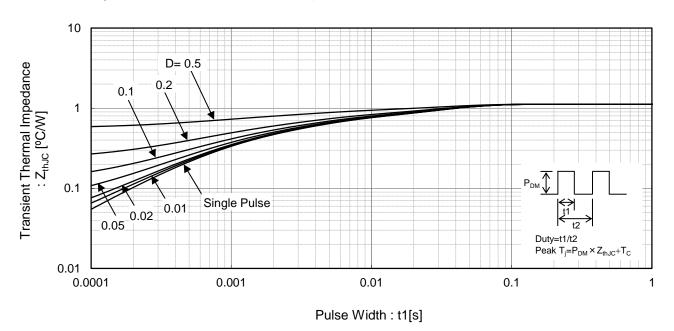
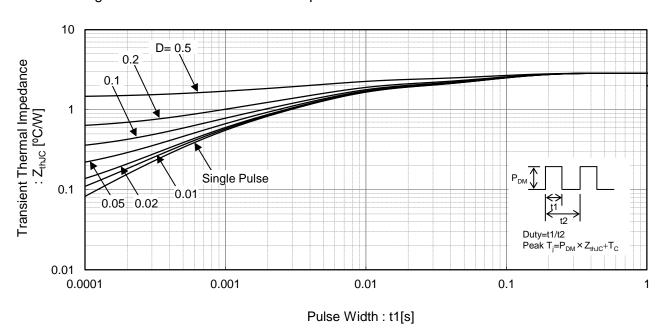


Fig.22 Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

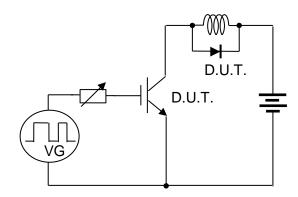


Fig.23 Inductive Load Circuit

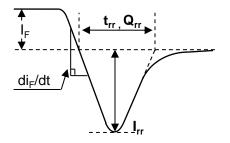


Fig.25 Diode Reverce Recovery Waveform

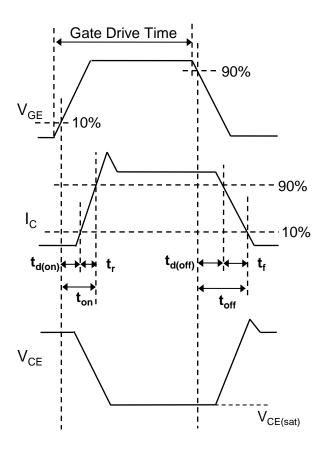


Fig.24 Inductive Load Waveform

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications:
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- 9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 11) ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 12) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 13) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 14) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ROHM Semiconductor:

RGT30NS65DGTL RGT30NS65DGC9